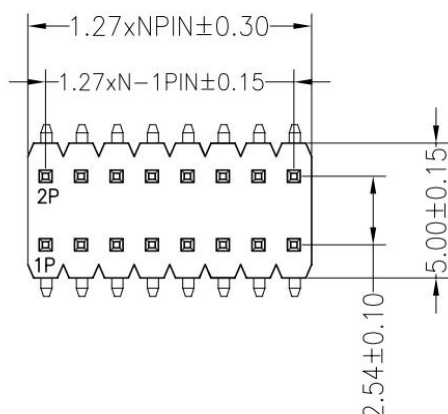
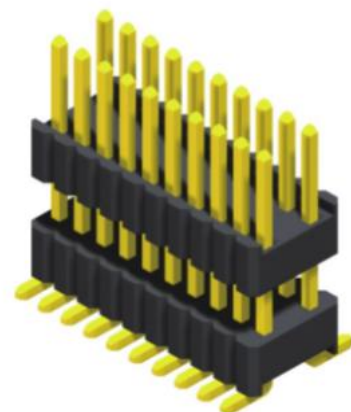
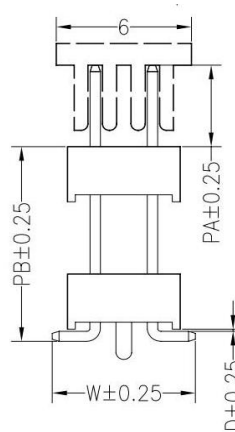
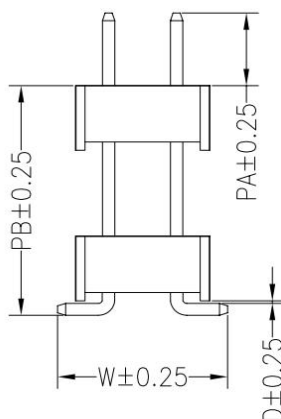
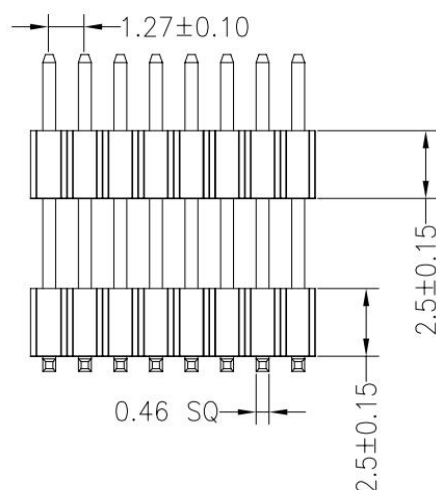
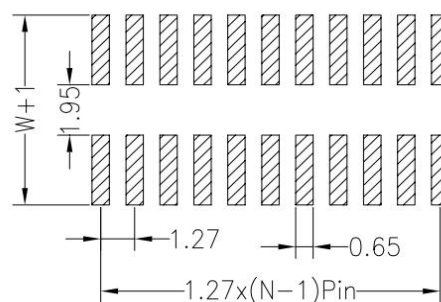


SPECIFICATIONS:

Rated Current	0.75AMP
Contact Resistance	30mΩ Max
Withstand Voltage	500V AC/DC
Insulation Resistance	1000mΩ Min
Operation Temperature	- 40°C to +105°C
Contact Material	Brass
Contact Plating	Au over Ni
Insulator Material	PA6T
Max. Processing Temp:	230°C for 30-60 seconds 260°C for 10 seconds

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

Dimension antitheses list					
ITEM	PA	PB	D	W	L
Standard	2.80	7.70	0.10	7.50	12.5
Alternate					

HC Series	No. of Pin Per Row	Insulator Option	N	Plating	Type	PIN Length	Packing	End code
HC-PH62522 1.27x2.54mm Pin Header	2x02P	A=PBT	W=Post	G0=Gold Flash	M=SMT	L=XXX	0=PE Bag	X
	2x50P	B=PA66	N=No Post	SN=Tin Plated		Confirm you	A=Tray	
		C=PA6T		SM=Matted Tin		need size of	T=Tube	
		D=PA46		S0=Gold/Tin		PA/PB/D/W	P=Tube+Cap	
		E=PA9T		G1=3u Gold			R=Reel+Cap	
		F=LCP		G2=5u Gold			M=Reel+Mylar	
		X=Special		G3=10u Gold			X=Special	
				G4=15u Gold				
				G5=30u Gold				
				S1=3u Gold/Tin				